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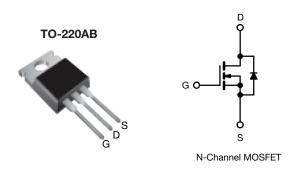
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	65	50			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.045			
Q _g max. (nC)	10	01			
Q _{gs} (nC)	2	24			
Q _{gd} (nC)	22				
Configuration	Sin	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP052N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	7 °
Continuous dusin suggest /T 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	48	А
Continuous drain current (T _J = 150 °C)		T _C = 100 °C		31	
Pulsed drain current ^a			I _{DM}	148	
Linear derating factor				2.2	W/°C
Single pulse avalanche energy b			E _{AS}	353	mJ
Maximum power dissipation			P _D	278	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dv/dt	100	Mar	
Reverse diode dv/dt ^d			50	- V/ns	
Soldering recommendations (peak temperature) c	ture) ^c For 10 s			260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 5 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 240 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R_{thJA}	=	62	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	0.45	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.61	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage		,	V _{GS} = ± 30 V		-	± 1	μΑ
Zeve gete veltege dvein euwent		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 23 A	-	0.045	0.052	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 23 A	-	11	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	3380	-	
Output capacitance	C _{oss}	,	$V_{DS} = 100 \text{ V},$	-	158	-	1
Reverse transfer capacitance	C _{rss}		f = 1 MHz		6	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	116	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	715	-	
Total gate charge	Qg			-	67	101	
Gate-source charge	Q_{gs}	$V_{GS} = 10 \text{ V}$	$V_{GS} = 10 \text{ V}$ $I_D = 23 \text{ A}, V_{DS} = 480 \text{ V}$		24	-	nC
Gate-drain charge	Q_gd			-	22	-	
Turn-on delay time	t _{d(on)}			-	31	62	
Rise time	t _r	$V_{DD} = 480 \text{ V}, I_D = 23 \text{ A},$		-	80	160	no
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		68	136	ns
Fall time	t _f			-	50	100	
Gate input resistance	R_g	f = 1 MHz, open drain		0.4	0.8	1.6	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	48	
Pulsed diode forward current	I _{SM}			-	-	148	A A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 23 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	148	296	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S = 23 A,	-	1.1	1.2	μC
Reverse recovery current	I _{RRM}	ai/at = 1	00 A/ μ s, V _R = 400 V	_	14	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- $b. \ \ C_{oss(tr)} \ is \ a \ fixed \ capacitance \ that \ gives \ the \ same \ charging \ time \ as \ C_{oss} \ while \ V_{DS} \ is \ rising \ from \ 0 \ \% \ to \ 80 \ \% \ V_{DSS} \ decreases \ d$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

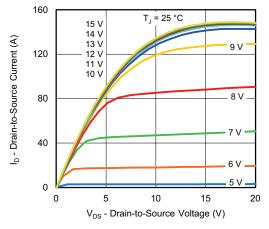


Fig. 1 - Typical Output Characteristics

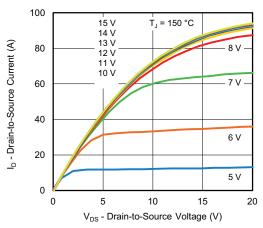


Fig. 2 - Typical Output Characteristics

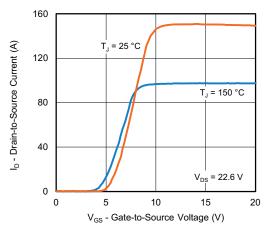


Fig. 3 - Typical Transfer Characteristics

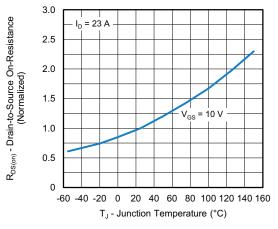


Fig. 4 - Normalized On-Resistance vs. Temperature

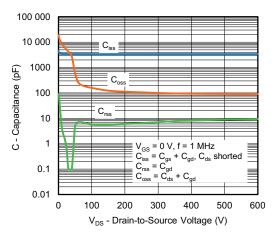


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

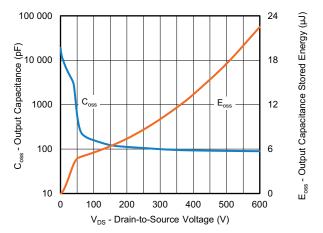


Fig. 6 - Coss and Eoss vs. VDS



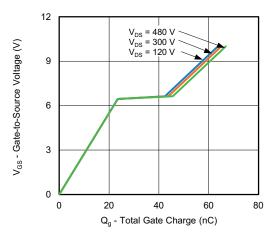


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

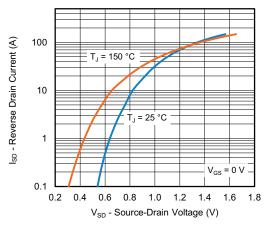


Fig. 8 - Typical Source-Drain Diode Forward Voltage

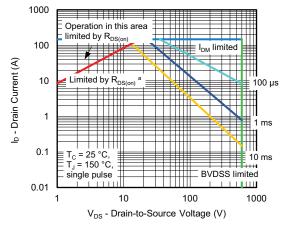


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

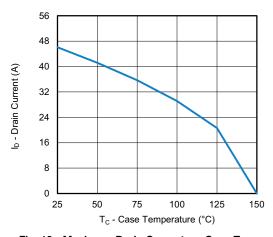


Fig. 10 - Maximum Drain Current vs. Case Temperature

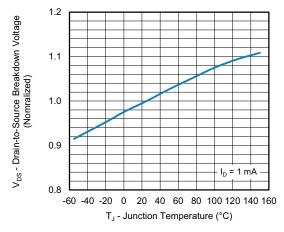


Fig. 11 - Temperature vs. Drain-to-Source Voltage



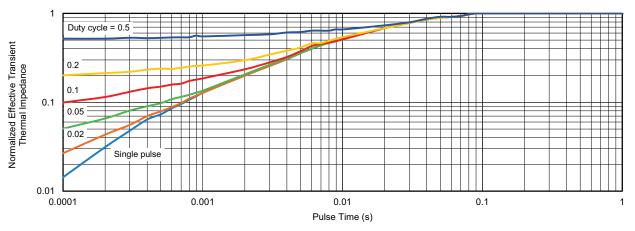


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

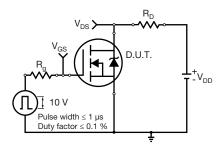


Fig. 13 - Switching Time Test Circuit

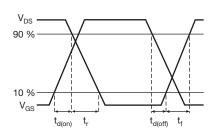


Fig. 14 - Switching Time Waveforms

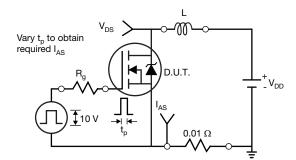


Fig. 15 - Unclamped Inductive Test Circuit

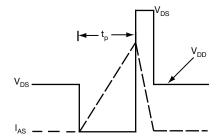


Fig. 16 - Unclamped Inductive Waveforms

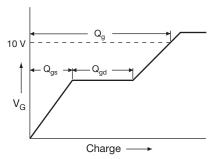


Fig. 17 - Basic Gate Charge Waveform

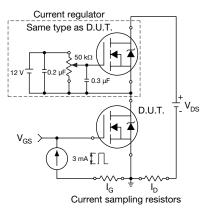


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit

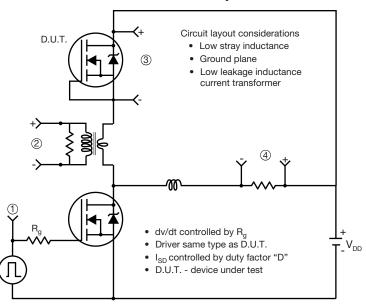


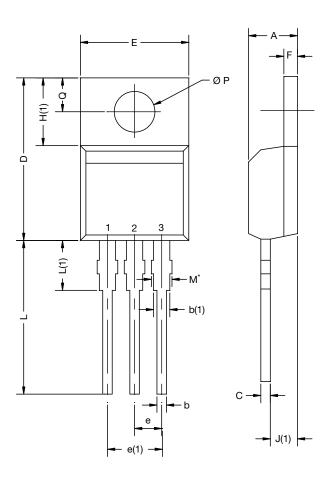


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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